



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Sabina J. Houle

Title: LIQUID SOLDER THERMAL INTERFACE MATERIAL CONTAINED WITHIN A COLD-FORMED BARRIER AND METHODS OF MAKING SAME

Docket No.: 884.860US1

Serial No.: 10/607,782

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Examiner: Matthew Warren

Group Art Unit: 2815

Customer No.: 21186

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Commissioner for Patents

Notice of Allowance Date:

Attn: MAIL STOP ISSUE FEE

January 3, 2007

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Attn – MAIL STOP ISSUE FEE, P.O. Box 1450, Alexandria, VA 22313-1450, on this 3 day of April, 2007.

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